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Team Nexperia

## **DISCRETE SEMICONDUCTORS**

## DATA SHEET

## PDTA143T series

PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

Product data sheet Supersedes data of 2003 Sep 08 2004 Aug 04



## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

### PDTA143T series

#### **FEATURES**

- Built-in bias resistors
- · Simplified circuit design
- Reduction of component count
- · Reduced pick and place costs.

#### **APPLICATIONS**

- General purpose switching and amplification
- · Inverter and interface circuits
- Circuit driver.

#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
$V_{CEO}$	collector-emitter voltage	_	-50	V
Io	output current (DC)	_	-100	mA
R1	bias resistor	4.7	_	kΩ
R2	open	_	_	_

#### **DESCRIPTION**

PNP resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

#### **PRODUCT OVERVIEW**

TVDE NUMBER	PAC	(AGE	MARKING CORE	NPN COMPLEMENT	
TYPE NUMBER	PHILIPS	EIAJ	MARKING CODE	NPN COMPLEMENT	
PDTA143TE	SOT416	SC-75	39	PDTC143TE	
PDTA143TEF	SOT490	SC-89	10	PDTC143TEF	
PDTA143TK	SOT346	SC-59	45	PDTC143TK	
PDTA143TM	SOT883	SC-101	E6	PDTC143TM	
PDTA143TS	SOT54 (TO-92)	SC-43	TA143T	PDTC143TS	
PDTA143TT	SOT23	-	*42 <sup>(1)</sup>	PDTC143TT	
PDTA143TU	SOT323	SC-70	*45 <sup>(1)</sup>	PDTC143TU	

#### Note

<sup>1. \* =</sup> p: Made in Hong Kong.

<sup>\* =</sup> t: Made in Malaysia.

<sup>\* =</sup> W: Made in China.

# PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

## PDTA143T series

#### SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	CIMPLIFIED OUTLINE AND CYMPOL		PINNING
TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PIN	DESCRIPTION
PDTA143TS	1 2 1 R1 3 3 MAM352	1 2 3	base collector emitter
PDTA143TE PDTA143TEF PDTA143TK PDTA143TT PDTA143TU	3 1 R1 3 Top view MDB272	1 2 3	base emitter collector
PDTA143TM	2 R1 3 Bottom view  MDB268	1 2 3	base emitter collector

## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

### PDTA143T series

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-5	V
Io	output current (DC)		_	-100	mA
I <sub>CM</sub>	peak collector current		_	-100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C			
	SOT23	note 1	_	250	mW
	SOT54	note 1	_	500	mW
	SOT323	note 1	_	200	mW
	SOT346	note 1	_	250	mW
	SOT416	note 1	_	150	mW
	SOT490	notes 1 and 2	_	250	mW
	SOT883	notes 2 and 3	_	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### **Notes**

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60  $\mu m$  copper strip line.

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air		
	SOT23	note 1	500	K/W
	SOT54	note 1	250	K/W
	SOT323	note 1	625	K/W
	SOT346	note 1	500	K/W
	SOT416	note 1	833	K/W
	SOT490	note 1	500	K/W
	SOT883	notes 2 and 3	500	K/W

#### Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60  $\mu m$  copper strip line.

## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

## PDTA143T series

#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	_	_	-100	nA
I <sub>CEO</sub>	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; I_B = 0$	_	_	-1	μΑ
		$V_{CE} = -30 \text{ V}; I_B = 0; T_j = 150 \text{ °C}$	_	_	-50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ mA}$	200	_	_	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = -5 \text{ mA}; I_B = -0.25 \text{ mA}$	_	_	-150	mV
R1	input resistor		3.3	4.7	6.1	kΩ
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0$ ; $V_{CB} = -10 \text{ V}$ ; $f = 1 \text{ MHz}$	_	_	3	pF

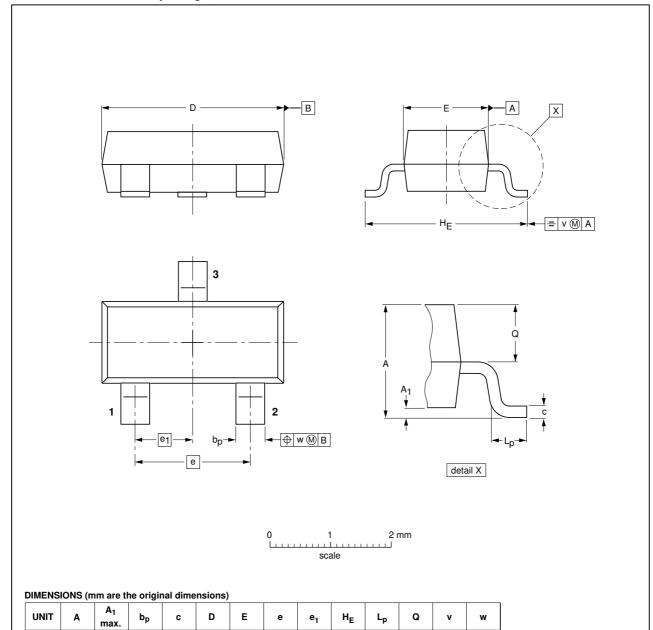
## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

## PDTA143T series

#### **PACKAGE OUTLINES**

Plastic surface-mounted package; 3 leads

SOT23



OUTLINE		REFER	EUROPEAN	IOOUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT23		TO-236AB				<del>-04-11-04-</del> 06-03-16

1.9

0.45

0.55

0.2

0.1

2004 Aug 04 6

0.48

0.38

0.15

1.1

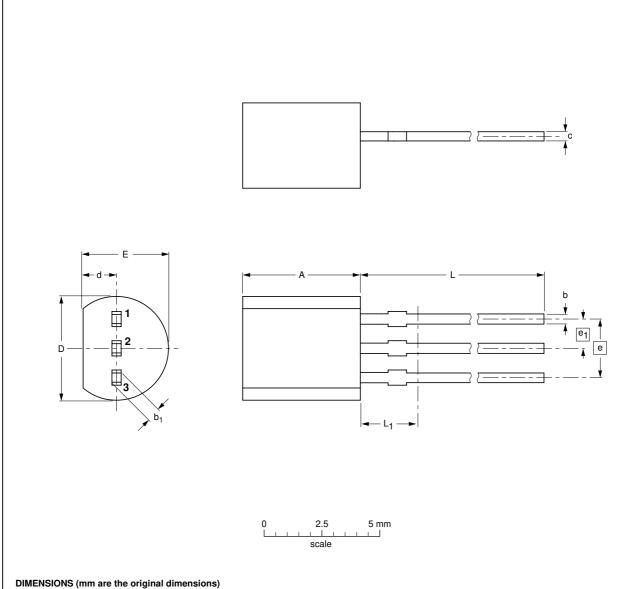
0.9

## PNP resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$ , R2 = open

## PDTA143T series

#### Plastic single-ended leaded (through hole) package; 3 leads

SOT54



UNIT	A	b	b <sub>1</sub>	С	D	d	E	е	e <sub>1</sub>	L	L <sub>1</sub> <sup>(1)</sup> max.	
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT54		TO-92	SC-43A		<del>-04-06-28-</del> 04-11-16	

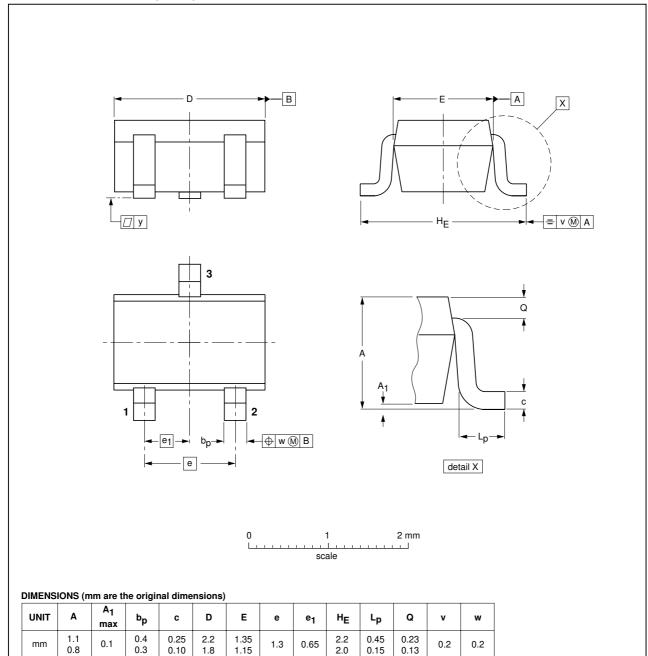
2004 Aug 04 7

## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

## PDTA143T series

#### Plastic surface-mounted package; 3 leads

**SOT323** 



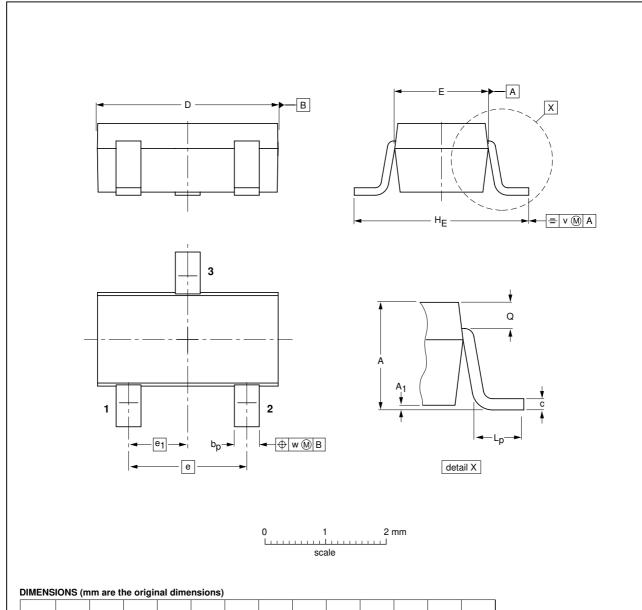
	OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
	VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
	SOT323			SC-70		<del>04-11-04</del> 06-03-16
L					-	

# PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

## PDTA143T series

#### Plastic surface-mounted package; 3 leads

SOT346



UNIT	A	A <sub>1</sub>	bp	С	D	E	е	e <sub>1</sub>	HE	Lp	Q	v	w
mm	1.3 1.0	0.1 0.013	0.50 0.35	0.26 0.10	3.1 2.7	1.7 1.3	1.9	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2

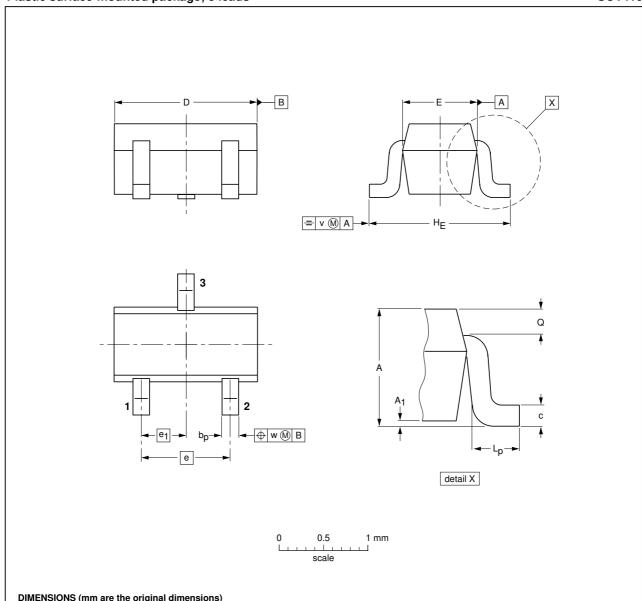
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT346		TO-236	SC-59A		<del>-04-11-11</del> 06-03-16

## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

## PDTA143T series

#### Plastic surface-mounted package; 3 leads

SOT416



DIME	CNOICNS	(mm are	; tne	originai	aimen	isions)	
							-

UNIT	Α	A <sub>1</sub> max	bp	С	D	E	е	e <sub>1</sub>	HE	Lp	ø	v	w
mm	0.95 0.60	0.1	0.30 0.15	0.25 0.10	1.8 1.4	0.9 0.7	1	0.5	1.75 1.45	0.45 0.15	0.23 0.13	0.2	0.2

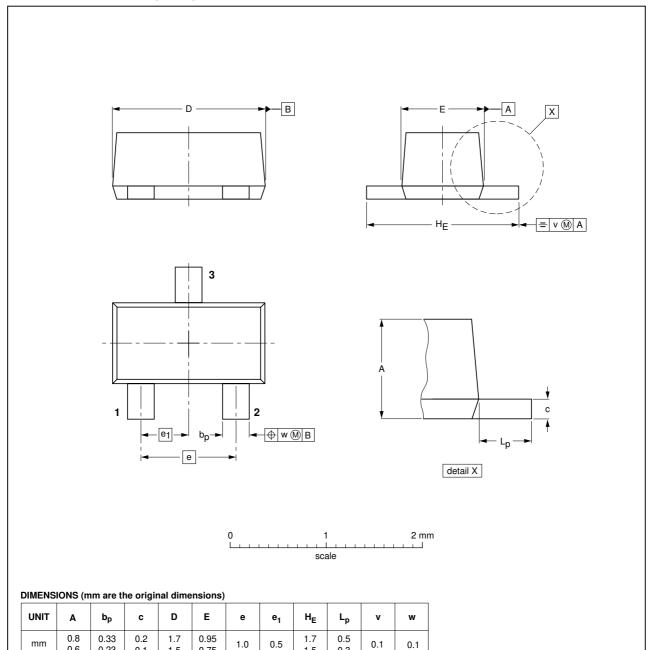
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION		
SOT416			SC-75		<del>04-11-04</del> 06-03-16	

## PNP resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$ , R2 = open

## PDTA143T series

#### Plastic surface-mounted package; 3 leads

SOT490



OUTLINE VERSION		REFER	EUROPEAN	ICCUE DATE		
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT490			SC-89			<del>05-07-28</del> 06-03-16

2004 Aug 04 11

1.5

0.6

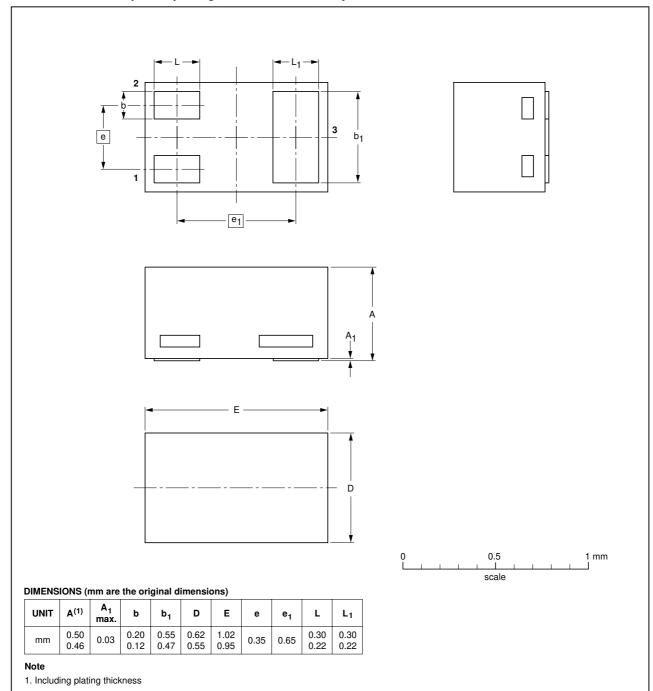
0.23

## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

## PDTA143T series

#### Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

**SOT883** 



OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT883			SC-101			<del>03-02-05</del> 03-04-03

## PNP resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = open

### PDTA143T series

#### **DATA SHEET STATUS**

DOCUMENT STATUS(1)	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

#### **Contact information**

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Printed in The Netherlands R75/04/pp14 Date of release: 2004 Aug 04 Document order number: 9397 750 13656

